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# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Kie Y. Ahn et al.

MULTILEVEL COPPER INTERCONNECT WITH DOUBLE PASSIVATION

Docket No.:

303.685US2

Serial No.: 10/721,920

Filed:

November 24, 2003

Due Date: N/A

Examiner:

Michael Trinh

Group Art Unit: 2822

#### MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- X Return postcard.
- X Communication Concerning Related Applications (1 pg.).
- X Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: Daniel J. Kluth

Reg. No. 32,146

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 2 day of October, 2005.

Judy Dent

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)



Title:

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# COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No. 10/349015 6,717,191	Filing Date/Issue Date January 21, 2003	Attorney Docket 303.482US2	<u>Title</u> ALUMINUM-BERYLLIUM ALLOYS FOR AIR BRIDGES
10/819025 6,943,090	April 6, 2004	303.482US3	ALUMINUM-BERYLLIUM ALLOYS FOR AIR BRIDGES
10/842243	May 10, 2004	1303.013US2	COPPER DUAL DAMASCENE INTERCONNECT TECHNOLOGY
10/930252	August 31, 2004	1303.116US1	INTEGRATED CIRCUIT COOLING AND INSULATING DEVICE AND METHOD
10/931541	August 31, 2004	303.648US2	METHODS FOR MAKING INTEGRATED- CIRCUIT WIRING FROM COPPER, SILVER, GOLD, AND OTHER METALS

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

KIE Y. AHN ET AL.

By Applicants' Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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Minneapolis, MN 55402

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Date Oct - 27 2005

Daniel J. Kluth

Reg. No. 32,146

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Judy Dent

Name

Signature

/N 10/721,920

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Kie Y. Ahn et al. plicant:

Examiner:

Michael Trinh

Serial No.:

10/721,920

Group Art Unit:

2822

Filed:

November 24, 2003

Docket:

303.685US2

Title:

MULTILEVEL COPPER INTERCONNECT WITH DOUBLE PASSIVATION

# SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Supplemental Information Disclosure Statement considered.

Filing Date: November 24, 2003

Title: MULTILEVEL COPPER INTERCONNECT WITH DOUBLE PASSIVATION

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Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938
Minneapolis, MN 55402
(612) 373-6904

Date Oct. 27, 2005 By Daniel J. Kluth
Reg. No. 32,146

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this day of October, 2005.

Judy Dent

Name

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Approved for use through 10/31/2002, OMB 651-0031
US Patent & Trademark Office: U.S. DEPARTMENT OF COMMERCE
office the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Tyle for form 1449A/PTO Complete if Known ORMATION DISCLOSURE 10/721,920 **Application Number** STATEMENT BY APPLICANT Filing Date November 24, 2003 (Use as many sheets as necessary) Ahn, Kie **First Named Inventor** 2822 **Group Art Unit** Trinh, Michael **Examiner Name** Attorney Docket No: 303.685US2 Sheet 1 of 1

	US PATENT DOCUMENTS					
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate		
	US-2003/0034560A1	02/20/2003	Matsuse, K., et al.	05/05/2000		
	US-2005/0023697A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004		
	US-4,933,743	06/12/1990	Thomas, M. E., et al.	08/14/1989		
	US-5,071,518	12/10/1991	Pan, J. T.	10/24/1989		
	US-5,374,849	12/20/1994	Tada, K.	03/01/1993		
	US-5,401,680	03/28/1995	Abt, N. E., et al.	02/18/1992		
	US-5,633,200	05/27/1997	Hu, Yongjun	05/24/1996		
	US-5,693,563	12/02/1997	Teong, S.	07/15/1996		
	US-5,719,447	02/17/1998	Gardner, D. S.	05/30/1995		
	US-5,789,264	08/04/1998	Chung, J.	09/26/1996		
	US-5,840,625	11/24/1998	Feldner, K.	10/04/1996		
	US-5,899,740	05/04/1999	Kwon, C.	09/04/1997		
	US-6,028,362	02/22/2000	Omura, M.	05/11/1998		
	US-6,030,895	02/29/2000	Joshi, R. V., et al.	07/29/1997		
	US-6,143,655	11/07/2000	Forbes, Leonard, et al.	02/25/1998		
	US-6,143,671	11/07/2000	Sugai, K.	11/19/1998		
	US-6,150,214	11/21/2000	Kaeriyama, T.	11/20/1998		
	US-6,169,024	01/02/2001	Hussein, M. A.	09/30/1998		
	US-6,174,804	01/16/2001	Hsu, C.	09/24/1998		
	US-6,215,186	04/10/2001	Konecni, A. J., et al.	01/05/1999		
	US-6,258,707	07/10/2001	Uzoh, C. E.	01/07/1999		
	US-6,288,447	09/11/2001	Amishiro, H., et al.	07/15/1999		
	US-6,417,094	07/09/2002	Zhao, B., et al.	12/31/1998		
,	US-6,492,266	12/10/2002	Ngo, M. V., et al.	07/09/1998		
	US-6,589,863	07/08/2003	Usami, T.	12/23/1999		
	US-6,943,090	09/13/2005	Farrar, P. A.	04/06/2004		

FOREIGN PATENT DOCUMENTS						
Examiner	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited	T <sup>2</sup>		
Initials*		1 45.1544.511 5415	Document			

OTHER DOCUMENTS NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T

**EXAMINER DATE CONSIDERED**